

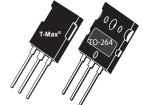
# APT106N60B2\_LC6

**600V 106A 0.035**Ω

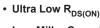


## **Super Junction MOSFET**

APT106N60B2C6



APT106N60LC6



• Low Miller Capacitance

• Ultra Low Gate Charge, Qg

· Avalanche Energy Rated

Extreme <sup>dv</sup>/<sub>dt</sub> Rated

· Dual die (parallel)

· Popular T-MAX and TO-264 Packages

Unless stated otherwise, Microsemi discrete MOSFETs contain a single MOSFET die. This device is made with two parallel MOSFET die. It is intended for switch-mode operation. It is not suitable for linear mode operation.



#### **MAXIMUM RATINGS**

All Ratings per die:  $T_C = 25^{\circ}C$  unless otherwise specified.

Symbol	Parameter	APT106N60B2_LC6	UNIT	
V <sub>DSS</sub>	Drain-Source Voltage	600	Volts	
	Continuous Drain Current @ T <sub>C</sub> = 25°C <sup>①</sup>	106		
I <sub>D</sub>	Continuous Drain Current @ T <sub>C</sub> = 100°C	68	Amps	
I <sub>DM</sub>	Pulsed Drain Current <sup>②</sup>	318		
$V_{GS}$	Gate-Source Voltage Continuous	±20	Volts	
$P_D$	Total Power Dissipation @ T <sub>C</sub> = 25°C	833	Watts	
$T_J$ , $T_{STG}$	Operating and Storage Junction Temperature Range	-55 - to 150	°C	
$T_L$	Lead Temperature: 0.063" from Case for 10 Sec.	260	C	
I <sub>AR</sub>	Avalanche Current <sup>②</sup>	18.6	Amps	
E <sub>AR</sub>	Repetitive Avalanche Energy <sup>③</sup> (Id = 18.6A, Vdd = 50V)	3.4		
E <sub>AS</sub>	Single Pulse Avalanche Energy ( ld = 18.6A, Vdd = 50V )	2200	mJ	

#### STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
BV <sub>(DSS)</sub>	Drain-Source Breakdown Voltage (V <sub>GS</sub> = 0V, I <sub>D</sub> = 500μA)	650			Volts
R <sub>DS(on)</sub>	Drain-Source On-State Resistance $^{\textcircled{4}}$ (V <sub>GS</sub> = 10V, I <sub>D</sub> = 53A)			0.035	Ohms
I <sub>DSS</sub>	Zero Gate Voltage Drain Current (V <sub>DS</sub> = 600V, V <sub>GS</sub> = 0V)			50	
	Zero Gate Voltage Drain Current (V <sub>DS</sub> = 600V, V <sub>GS</sub> = 0V, T <sub>C</sub> = 150°C)			500	μA
I <sub>GSS</sub>	Gate-Source Leakage Current (V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V)			±200	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage (V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 3.4mA)	2.5	3	3.5	Volts

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

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#### **DYNAMIC CHARACTERISTICS**

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C <sub>iss</sub>	Input Capacitance	V <sub>00</sub> = 0V		8390		
C <sub>oss</sub>	Output Capacitance	$V_{GS} = 0V$ $V_{DS} = 25V$		7115		pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1 MHz		229		
$Q_g$	Total Gate Charge <sup>⑤</sup>	V <sub>GS</sub> = 10V		308		
$Q_{gs}$	Gate-Source Charge	$V_{DD} = 300V$		50		nC
$Q_{gd}$	Gate-Drain ("Miller") Charge	I <sub>D</sub> = 106A @ 25°C		160		
t <sub>d(on)</sub>	Turn-on Delay Time	INDUCTIVE SWITCHING		25		
t <sub>r</sub>	Rise Time	$V_{GS} = 15V$ $V_{DD} = 400V$		79		ns
t <sub>d(off)</sub>	Turn-off Delay Time	I <sub>D</sub> = 106A @ 25°C		277		115
t <sub>f</sub>	Fall Time	$R_{\rm G} = 4.3\Omega$		164		
E <sub>on</sub>	Turn-on Switching Energy ®	INDUCTIVE SWITCHING @ 25°C V <sub>DD</sub> = 400V, V <sub>GS</sub> = 15V		2995		
E <sub>off</sub>	Turn-off Switching Energy	$I_{D} = 106A, R_{G} = 4.3\Omega$		3775		
E <sub>on</sub>	Turn-on Switching Energy <sup>⑥</sup>	INDUCTIVE SWITCHING @ 125°C V <sub>DD</sub> = 400V, V <sub>GS</sub> = 15V		4055		μJ
E <sub>off</sub>	Turn-off Switching Energy	$V_{DD} = 400V, V_{GS} = 15V$ $I_{D} = 106A, R_{G} = 4.3\Omega$		4200		

### SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS.

Symbol	Characteristic / Test Conditions		MIN	TYP	MAX	UNIT
Is	Continuous Source Current (Body Diode)				92	Amno
I <sub>SM</sub>	Pulsed Source Current <sup>②</sup> (Body Diode)		ĺ		318	Amps
V <sub>SD</sub>	Diode Forward Voltage ④ (V <sub>GS</sub> = 0V, I <sub>S</sub> = -106A)			0.9	1.2	Volts
dv/ <sub>dt</sub>	Peak Diode Recovery dv/ <sub>dt</sub> (7)				15	V/ns
t <sub>rr</sub>	Reverse Recovery Time $(I_s = -106A, di/dt = 100A/\mu s)$	T <sub>i</sub> = 25°C		1400		ns
Q <sub>rr</sub>	Reverse Recovery Charge (I <sub>s</sub> = -106A, <sup>di</sup> / <sub>dt</sub> = 100A/μs)	T <sub>i</sub> = 25°C		45		μC
I <sub>RRM</sub>	Peak Recovery Current (I <sub>s</sub> = -106A, <sup>di</sup> / <sub>dt</sub> = 100A/μs)	T <sub>i</sub> = 25°C		47		Amps

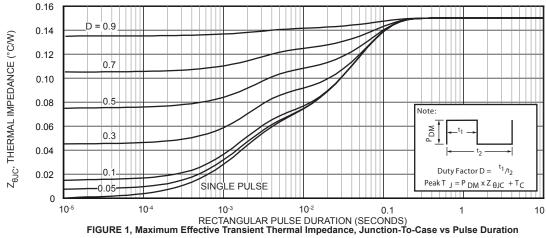
## THERMAL AND MECHANICAL CHARACTERISTICS

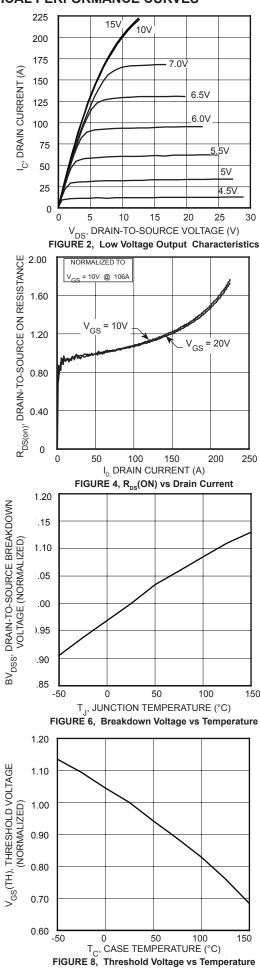
Symbol	Characteristic	MIN	TYP	MAX	UNIT
$R_{\scriptscriptstyle{\theta JC}}$	Junction to Case			0.15	°C/W
$R_{\theta JA}$	Junction to Ambient			40	
W <sub>T</sub>	Package Weight		0.22		oz
			6.2		g
Torque	Mounting Torque (TO-264 Package), 4-40 or M3 screw			10	in∙lbf
Torque				1.1	N·m

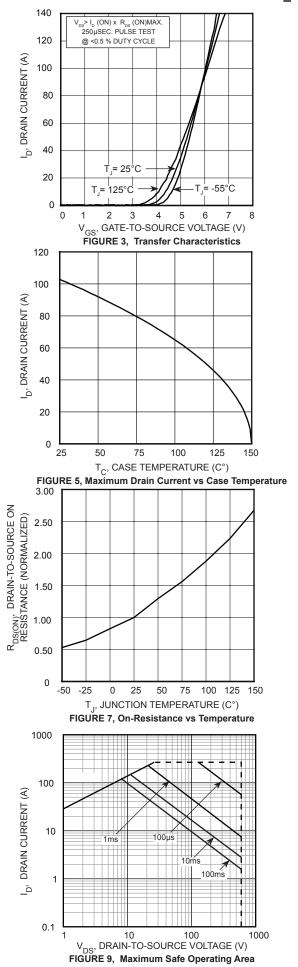
- 1 Continuous current limited by package lead temperature.
- 2 Repetitive Rating: Pulse width limited by maximum junction temperature
- 3 Repetitive avalanche causes additional power losses that can be calculated
- as  $P_{AV} = E_{AR}^* f$ . Pulse width tp limited by Tj max.

- 4 Pulse Test: P
- 5 See MIL-STD-750 Method 3471
- 6 Eon includes diode reverse recovery.
- 7 Maximum 125°C diode commutation speed = di/dt 600A/µs

Microsemi reserves the right to change, without notice, the specifications and information contained herein.







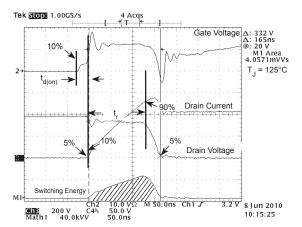


FIGURE 17, Turn-on Switching Waveforms and Definitions

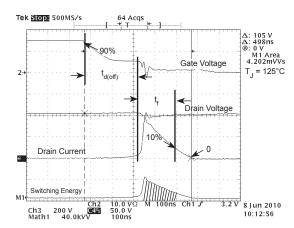


FIGURE 18, Turn-off Switching Waveforms and Definitions

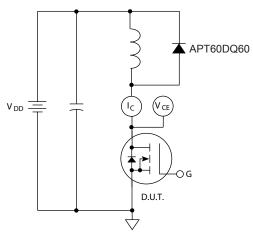
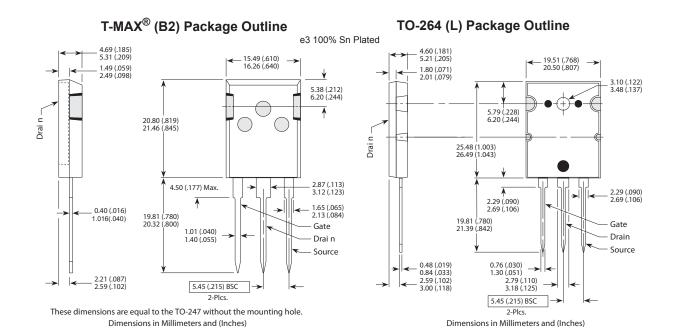


FIGURE 19, Inductive Switching Test Circuit



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